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Silicon Carbide (SiC) MOSFET – 20 mohm, 900 V, M2, TO-247-3L

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
900 V	28 mΩ @ 15 V	118 A

NVHL020N090SC1

Features

- Typ. $R_{DS(on)} = 20 \text{ m}\Omega @ V_{GS} = 15 \text{ V}$
- Typ. $R_{DS(on)} = 16 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge (typ. Q_{G(tot)} = 196 nC)
- Low Effective Output Capacitance (typ. Coss = 296 pF)
- 100% UIL Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

Typical Applications

- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	900	V	
Gate-to-Source Voltag	ge		V _{GS}	+22/-8	V
Recommended Operat Values of Gate-Source			V _{GSop}	+15/-5	V
$\begin{array}{l} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady State	$T_C = 25^{\circ}C$	I _{DC}	118	А
Power Dissipation $R_{\theta JC}$			P _{DC}	503	W
$\begin{array}{l} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady T _C = 100°C State		I _{DC}	83	А
Power Dissipation $R_{\theta JC}$			P _{DC}	251	W
Pulsed Drain Current (Note 2)	$T_A = 25^{\circ}C$	I _{DM}	472	А
Single Pulse Surge Drain Current Capability(Note 3)	$T_{A} = 25^{\circ}C, t_{p} = 10 \ \mu s, \\ R_{G} = 4.7 \ \Omega$		I _{DSC}	854	A
Operating Junction and Range	perating Junction and Storage Temperature ange		T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)		Is	153	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_L = 23 A_{pk}, L = 1 \text{ mH}$) (Note 4)		E _{AS}	264	mJ	

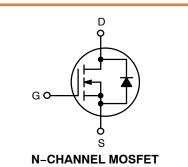
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. Peak current might be limited by transconductance.

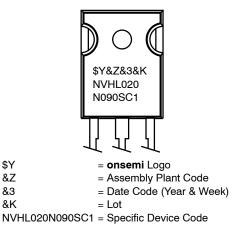
4. EAS of 264 mJ is based on starting TJ = 25°C; L = 1 mH, IAS = 23 A, $V_{DD} = 100 \text{ V}, V_{GS} = 15 \text{ V}.$





TO-247 LONG LEADS CASE 340CX

MARKING DIAGRAM



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ORDERING INFORMATION

Device	Package	Shipping
NVHL020N090SC1	TO-247 Long Lead	30 Units / Tube

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Мах	Units
Thermal Resistance Junction-to-Case (Note 1)	$R_{\theta JC}$	0.30	°C/W
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Test	Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA		900			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, refer to 25°C			500		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	S $V_{GS} = 0 V,$ $T_J = 25^{\circ}C$			100	μΑ	
	$V_{DS} = 900 \text{ V}$ $T_{J} = 175^{\circ}\text{C}$	T _J = 175°C			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = +22/-8 \	/, V _{DS} = 0 V			±1	μΑ
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, I_D	= 20 mA	1.8	2.7	4.3	V
Recommended Gate Voltage	V _{GOP}			-5		+15	V
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 18 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$			20	28	mΩ
					16		
		V_{GS} = 15 V, I _D = 60 A, T _J = 175°C		27			
Forward Transconductance	9 _{FS}	V _{DS} = 20 V, I _D = 60 A			49		S
CHARGES, CAPACITANCES & GATE R	ESISTANCE						
Input Capacitance	C _{ISS}	$V_{GS} = 0 V, f = 1$	MHz,		4415		pF
Output Capacitance	C _{OSS}	V _{DS} = 450 V			296		
Reverse Transfer Capacitance	C _{RSS}				24		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/15 V,$	V _{DS} = 720 V,		196		nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 60 A			42		
Gate-to-Source Charge	Q _{GS}				78		
Gate-to-Drain Charge	Q _{GD}	1			55		
Gate-Resistance	R _G	f = 1 MHz			1.6		Ω
SWITCHING CHARACTERISTICS				-	•		
Turn-On Delay Time	t _{d(ON)}	V _{GS} = -5/15 V,			40		ns
Rise Time	t _r	I_D = 60 A, R_G = 2.5 Ω , Inductive Load			63		
Turn-Off Delay Time				<u> </u>	55	l	

	۲	Inductive Load	03	
Turn-Off Delay Time	t _{d(OFF)}		55	
Fall Time	t _f		13	
Turn-On Switching Loss	E _{ON}		2025	μJ
Turn-Off Switching Loss	E _{OFF}		201	
Total Switching Loss	E _{TOT}		2226	
DRAIN-SOURCE DIODE CHARACTERIST	CS			

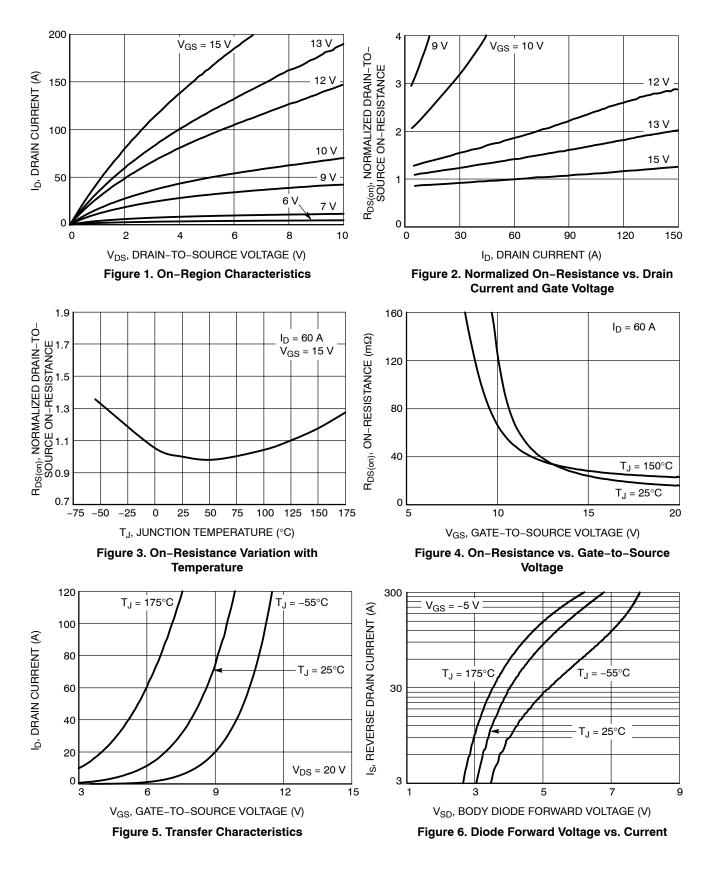
Continuous Drain-Source Diode Forward Current	I _{SD}	V_{GS} = -5 V, T_{J} = 25°C		153	А
Pulsed Drain-Source Diode Forward Current (Note 2)	I _{SDM}	V_{GS} = -5 V, T_{J} = 25°C		472	A
Forward Diode Voltage	V _{SD}	V_{GS} = -5 V, I _{SD} = 30 A, T _J = 25°C	3.8		V

Table 2. ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise stated)

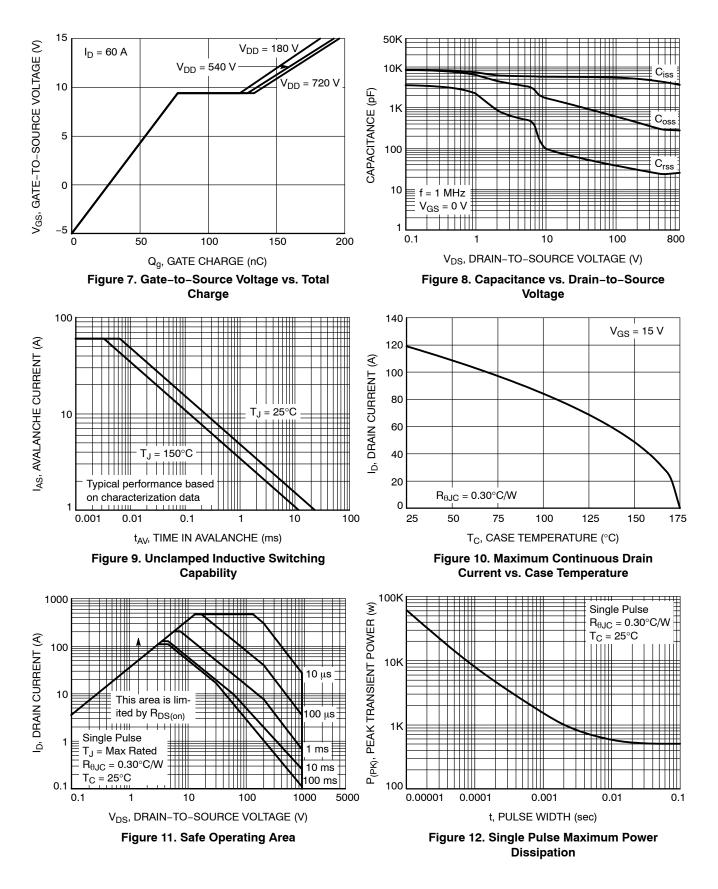
Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit		
DRAIN-SOURCE DIODE CHARACTERISTICS								
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/15 \text{ V}, I_{SD} = 60 \text{ A},$		28		ns		
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 Å/µs, V _{DS} = 720 V		199		nC		
Reverse Recovery Energy	E _{REC}			4		μJ		
Peak Reverse Recovery Current	I _{RRM}	1		14		А		
Charge Time	Та	1		16		ns		
Discharge Time	Tb]		12		ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

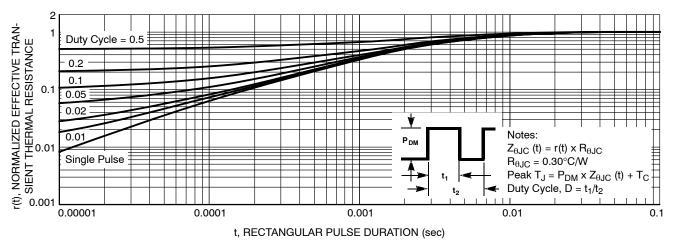
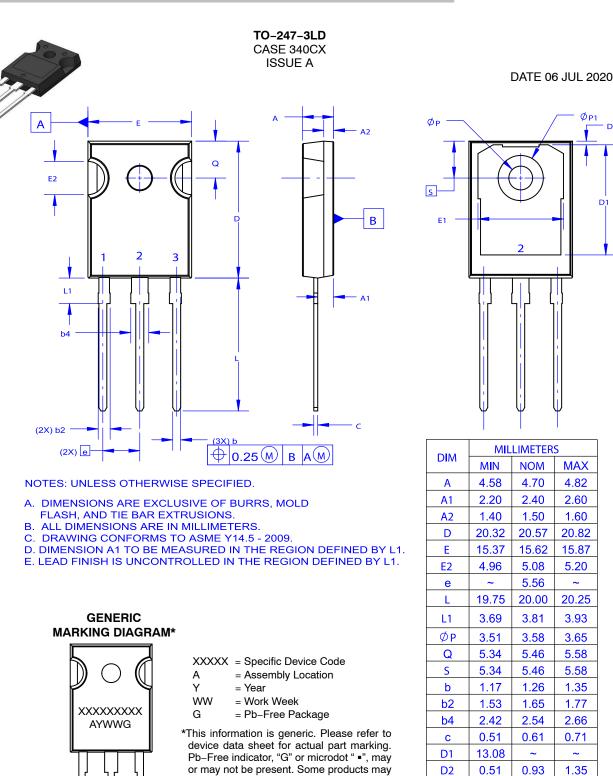


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



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